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This paper describes epitaxial GaAs Hall sensors designed for use as a digital pulsing transmitter from rotation at high temperature above 100°C. High temperature characteristics of the devices are emphasized. No Hall sensor commercially available functions at this temperature range because of the narrower band gap of the materials than that of GaAs.

The devices were fabricated utilizing epitaxial n-GaAs grown on semiinsulating GaAs. The thickness and the carrier concentration of the epitaxial layers which determine the Hall voltage $V_{\rm H}$ and the device resistance $R_{\rm d}$, were designed accordingly. Table 1 is a list of the devices fabricated and the characteristics of the wafers from which the devices were produced.

A top view of a device chip after separation is shown in Figure 1. Mesa etching isolates and forms the devices on the semiinsulating substrate. Ohmic contacts are formed using Au-Ge alloy.

Figure 2 is temperature dependence of the Hall voltage measured at 5 Kgauss. Except #154 in which the Hall voltage decreased rapidly above 150°C, the devices function with good stability up to 280°C that is limited by the contact metal structure. Temperature coefficients of the Hall voltage, $\frac{1}{V_H} \times \frac{dV_H}{dT}$ are about -1.8 x 10⁻⁴/°C at 100°C and -0.5 x 10⁻⁴/°C at 150°C, which are tenth of that of Si Hall sensors at these temperatures.



In #154 device, the reduction of the Hall voltage coinsides with that of the device resistance as is shown in Figure 3. Figure 3 is the temperaFig. 1. Top view of a Hall sensor chip.

ture dependence of $V_{\rm H}$ and $R_{\rm d}$ in a device #154-1 along with the data taken with a device #154-2 in which a major part of the epitaxial layer has been etched off to make the effect conspicuous.

Sample No.	Carrier Conc. (cm ⁻³)	Thickness (um)	Calculated (1)		Observed	
			V _H (5kG) (mV)	R _d (Ω)	V _H (5kG) (mV)	Rd (2)
#154	9.0x1015	0.7	449	3,360	430~480	3,260~3,580
#157	4.6x10 ¹⁵	1.6	385	2,780	362~410	2,690~3,020
#162	1.9x10 ¹⁶	5.0	29.8	257	25∿ 31	200- 290
\$151	8.6x10 ¹⁶	1.3	25.3	287	23~ 27	250~ 280

Table 1. List of wafers and devices fabricated.

-79-

The activation energy calculated from the slopes in $V_{\rm H}$ vs. T and $R_{\rm d}$ vs. T curves gives a donor level lying at 0.8 eV from conduction band, which has been assigned to Oxygen.⁽²⁾

Carrier concentration profiles of the layers were measured at high temperature using C-V data of Schottky barrier formed on the epitaxial layer. In the layer #154, it was observed that a frequency dependence of the carrier concentration and a thickening of the conductive layer. A profile of electron mobility in the layer was also measured at room temperature with a Hall specimen with a Schottky gate formed on current path.⁽³⁾ There was a definite correlation be-







Fig. 3. Temperature dependence of $\rm V_{\rm H}$ and $\rm R_{\rm d}$ in the samples #154.

device resistance Rd(Ω)	3.000
control current (typ.) Ic (riA)	10
hall voltage @5kG @Ic V _H (5kG) (mV)	4,000
sensitivity (mV/mA·kG)	80
max. magnetic flux density sensitivity (V/kG)	3
linearity $V_{\rm H}(B)/V_{\rm H}(1kG)$ $e_{\rm R_L} = \infty$ (%)	<1
temperature coefficients @150°C (%/°C)	-0.5x10-2
residual voltage $V_{\rm H}(0)/V_{\rm H}(5\rm kG)$ (%)	<2
operational temperature range °C	-70-200

Table. 2. List of typical characteristics of epitaxial GaAs Hall sensor. tween an appearance of the low mobility region at the boundary and the phenomena stated above. Discussions which brought about a conclusion that the incorporation of Oxygen from a possible leak into the epitaxial layer will be reported.

To realize cost down of the devices, (1) mass production of GaAs layers by C.V.D., (2)utilization of low quality (high etch pits density) substrates and (3) optimization of specifications for a high yield, have been investigated with satisfactory results.

In table 2, characteristics of the epitaxial GaAs Hall sensors are summerized.

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